

## **RECTANGULAR POWER CONNECTORS**





✓ Active



PRODUCT DRAWING



3D PDF

TE CONNECTIVITY (TE)

RCPT ASY, VRT, AMPINRGY WTB, 3POS

AMPINNERGY | Power Wiring Devices

556881-3

TE Internal Number: 556881-3

Always EU RoHS/ELV Compliant

Product Type Connector Assembly

Housing Type Receptacle

Connector System Wire-to-Board

Applies To Printed Circuit Board

Contact Current Rating (A) 35

**Product Drawings** 

RECEPTABLE ASSEMBLY, VERTICLE, WTB, AMPINNERGY

PDF **English** 

CAD Files

3D PDF

PDF **English** 

**Customer View Model** 

2D\_DXF.ZIP English

Customer View Model

3D\_IGS.ZIP **English** 

Customer View Model

3D\_STP.ZIP English

Catalog Pages/Data Sheets

POWER\_CONNECTORS\_CATALOG\_SEC02\_CABLE\_MOUNTED

PDF **English** 

1654742\_HOUSEHOLD\_APPLIANCES\_RAST5

PDF **English** 

**Product Specifications** 

Product Specification Connector, AMPINNERGY\*, Wire-To-Board

PDF **English** 

Application Specification AMPINNERGY Wire-To-Board (WTB) Connectors

PDF **English** 

AMPINNERGY Modular Wiring System

PDF **English** 

Product Environmental Compliance

PDF English

## Instruction Sheets

Instruction Sheet (U.S.)

AMP NETCONNECT AMPINNERGY Wire-To-Board (WTB) Connectors 556870-[],

556882-[], And 556881-[]

PDF **English** 

Please review product documents or contact us for the latest agency approval information. Please Note: Use the Product Drawing for all design activity.

Product Type Features  Housing Type Contact Type Prin/Socket  Contact Type Prin/Socket  Configuration Features  Number of Positions Centerline PCB Mounting Orientation Vertical Number of Rows 1 Contact Layout Inline  Electrical Characteristics Contact Current Rating (A) Operating Voltage (VAC)  Contact Features  Contact Features Contact Termination Area Plating Material Contact Mating Area Plating Thickness 3.81 µm [150 µin] Contact Base Material Contact Design Contact Termination Area Plating Thickness 2.54 µm [100 µin]  Termination Features  Wire/Cable Size (AWG) Termination Method to PC Board Wer Type Termination Post/Tal Length Mating Alignment Mating Alignment Mating Alignment Mating Resention With Mating Resention With				
Configuration Features  Number of Positions 3 Centerline 11.18 mm [.44 in] PCB Mounting Orientation Vertical Number of Rows 1 Contact Layout Inline  Electrical Characteristics  Contact Current Rating (A) Operating Voltage (VAC)  Contact Features  Contact Termination Area Plating Material Tin Contact Mating Area Plating Material Tin Contact Mating Area Plating Thickness 3.81 µm [150 µin] Contact Design Dual Beam Contact Termination Area Plating Thickness Contact Termination Area Plating Thickness Termination Features  Wire/Cable Size (AWG) Termination Method to PC Board Through Hole - Solder Termination Post/Tail Length Mating Alignment Mating Alignment Mating Alignment Mating Retention With	Product Type Features	Product Type	Connector Assembly	
Configuration Features  Number of Positions  Centerline  11.18 mm [.44 in.]  PCB Mounting Orientation  Vertical  Number of Rows  1  Contact Layout  Inline  Electrical Characteristics  Contact Current Rating (A)  Operating Voltage (VAC)  600  Contact Features  Contact Termination Area Plating Material  Tin  Contact Mating Area Plating Material  Tin  Contact Mating Area Plating Thickness  3.81 µm [150 µin.]  Contact Base Material  Contact Design  Contact Termination Area Plating Thickness  2.54 µm [100 µin.]  Termination Features  Wire/Cable Size (AWG)  Termination Method to PC Board  Wire Type  Stranded  Termination Post/Tail Length  Methanical Attachment  Mating Alignment  Mith  Mating Retention  With		Housing Type	Receptacle	
Centerline 11.18 mm [.44 in] PCB Mounting Orientation Vertical Number of Rows 1 Contact Layout Inline  Electrical Characteristics Contact Current Rating (A) 35 Operating Voltage (VAC) 400  Contact Features Contact Termination Area Plating Material Tin Contact Mating Area Plating Material Tin Contact Mating Area Plating Thickness 3.81 µm [150 µin] Contact Base Material Copper Alloy Contact Design Dual Beam Contact Termination Area Plating Thickness 2.54 µm [100 µin]  Termination Features Wire/Cable Size (AWG) 6 – 20 Termination Method to PC Board Through Hole - Solder Wire Type Stranded Termination Post/Tail Length 4.9 mm [.1929 in]  Mechanical Attachment Mating Alignment With		Contact Type	Pin/Socket	
PCB Mounting Orientation Vertical Number of Rows 1 Contact Layout Inline  Electrical Characteristics Contact Current Rating (A) Operating Voltage (VAC) 600  Contact Features Contact Termination Area Plating Material Contact Mating Area Plating Material Tin Contact Mating Area Plating Material Contact Mating Area Plating Thickness 3.81 µm [150 µin] Contact Base Material Copper Alloy Contact Design Dual Beam Contact Termination Area Plating Thickness 2.54 µm [100 µin]  Termination Features Wire/Cable Size (AWG) Termination Method to PC Board Through Hole - Solder Wire Type Stranded Termination Post/Tail Length Mating Alignment Mating Alignment Mating Retention With	Configuration Features	Number of Positions	3	
Number of Rows 1 Contact Layout Inline  Electrical Characteristics Contact Current Rating (A) 35 Operating Voltage (VAC) 600  Contact Features Contact Termination Area Plating Material Tin Contact Mating Area Plating Material Tin Contact Mating Area Plating Thickness 3.81 µm [150 µin] Contact Base Material Copper Alloy Contact Design Dual Beam Contact Termination Area Plating Thickness 2.54 µm [100 µin]  Termination Features Wire/Cable Size (AWG) 6-20 Termination Method to PC Board Through Hole - Solder Wire Type Stranded Termination Post/Tail Length 4.9 mm [.1929 in]  Mechanical Attachment Mating Alignment With Mating Retention With		Centerline	11.18 mm [ .44 in ]	
Electrical Characteristics  Contact Current Rating (A) 35 Operating Voltage (VAC) 600  Contact Features  Contact Termination Area Plating Material Contact Mating Area Plating Material Tin Contact Mating Area Plating Thickness 3.81 µm [150 µin] Contact Base Material Contact Base Material Contact Design Dual Beam Contact Termination Area Plating Thickness 2.54 µm [100 µin]  Termination Features  Wire/Cable Size (AWG) Termination Method to PC Board Through Hole - Solder Wire Type Stranded Termination Post/Tail Length Mechanical Attachment Mating Alignment Mating Retention With		PCB Mounting Orientation	Vertical	
Electrical Characteristics  Contact Current Rating (A) 35 Operating Voltage (VAC)  600  Contact Features  Contact Termination Area Plating Material Tin Contact Mating Area Plating Material Contact Mating Area Plating Thickness 3.81 µm [150 µin] Contact Base Material Copper Alloy Contact Design Dual Beam Contact Termination Area Plating Thickness 2.54 µm [100 µin]  Termination Features  Wire/Cable Size (AWG) Termination Method to PC Board Through Hole - Solder Wire Type Stranded Termination Post/Tail Length  Mechanical Attachment Mating Alignment With Mating Retention With		Number of Rows	1	
Contact Features  Contact Termination Area Plating Material Contact Mating Area Plating Material Tin Contact Mating Area Plating Thickness 3.81 µm [150 µin] Contact Base Material Copper Alloy Contact Design Dual Beam Contact Termination Area Plating Thickness 2.54 µm [100 µin]  Termination Features  Wire/Cable Size (AWG) Termination Method to PC Board Through Hole - Solder Wire Type Termination Post/Tail Length  Mating Alignment Mating Retention  With		Contact Layout	Inline	
Contact Features  Contact Termination Area Plating Material  Contact Mating Area Plating Material  Tin  Contact Mating Area Plating Thickness  3.81 µm [150 µin]  Contact Base Material  Copper Alloy  Contact Design  Dual Beam  Contact Termination Area Plating Thickness  2.54 µm [100 µin]  Termination Features  Wire/Cable Size (AWG)  Termination Method to PC Board  Wire Type  Stranded  Termination Post/Tail Length  Mating Alignment  Mating Alignment  Mating Retention  With	Electrical Characteristics	Contact Current Rating (A)	35	
Contact Mating Area Plating Material  Contact Mating Area Plating Thickness  3.81 µm [150 µin]  Contact Base Material  Copper Alloy  Contact Design  Dual Beam  Contact Termination Area Plating Thickness  2.54 µm [100 µin]  Termination Features  Wire/Cable Size (AWG)  Termination Method to PC Board  Wire Type  Stranded  Termination Post/Tail Length  Mechanical Attachment  Mating Alignment  Mating Retention  With		Operating Voltage (VAC)	600	
Contact Mating Area Plating Thickness 3.81 µm [150 µin]  Contact Base Material Copper Alloy  Contact Design Dual Beam  Contact Termination Area Plating Thickness 2.54 µm [100 µin]  Termination Features Wire/Cable Size (AWG) 6 – 20  Termination Method to PC Board Through Hole - Solder  Wire Type Stranded  Termination Post/Tail Length 4.9 mm [.1929 in]  Mechanical Attachment Mating Alignment With  Mating Retention With	Contact Features	Contact Termination Area Plating Material	Tin	
Contact Base Material Contact Design Dual Beam Contact Termination Area Plating Thickness 2.54 µm [100 µin]  Termination Features Wire/Cable Size (AWG) Termination Method to PC Board Through Hole - Solder Wire Type Stranded Termination Post/Tail Length 4.9 mm [.1929 in]  Mechanical Attachment Mating Alignment Mating Retention With		Contact Mating Area Plating Material	Tin	
Contact Design  Contact Termination Area Plating Thickness  2.54  pm [100 pin]  Termination Features  Wire/Cable Size (AWG)  Termination Method to PC Board  Wire Type  Stranded  Termination Post/Tail Length  Mechanical Attachment  Mating Alignment  Mating Retention  With		Contact Mating Area Plating Thickness	3.81 μm [ 150 μin ]	
Contact Termination Area Plating Thickness  2.54 µm [ 100 µin ]  Termination Features  Wire/Cable Size (AWG)  Termination Method to PC Board  Wire Type  Stranded  Termination Post/Tail Length  4.9 mm [.1929 in ]  Mechanical Attachment  Mating Alignment  Mating Retention  With		Contact Base Material	Copper Alloy	
Termination Features  Wire/Cable Size (AWG)  Termination Method to PC Board  Wire Type  Stranded  Termination Post/Tail Length  4.9 mm [.1929 in]  Mechanical Attachment  Mating Alignment  Mating Retention  With		Contact Design	Dual Beam	
Termination Method to PC Board  Wire Type  Stranded  Termination Post/Tail Length  4.9 mm [.1929 in]  Mechanical Attachment  Mating Alignment  Mating Retention  With		Contact Termination Area Plating Thickness	2.54 μm [ 100 μin ]	
Wire Type Stranded  Termination Post/Tail Length 4.9 mm [.1929 in]  Mechanical Attachment Mating Alignment With  Mating Retention With	Termination Features	Wire/Cable Size (AWG)	6 – 20	
Termination Post/Tail Length 4.9 mm [.1929 in]  Mechanical Attachment Mating Alignment With  Mating Retention With		Termination Method to PC Board	Through Hole - Solder	
Mechanical Attachment Mating Alignment With  Mating Retention With		Wire Type	Stranded	
Mating Retention With		Termination Post/Tail Length	4.9 mm [ .1929 in ]	
	Mechanical Attachment	Mating Alignment	With	
PCB Mount Retention With		Mating Retention	With	
		PCB Mount Retention	With	

	PCB Mount Retention Type	Mounting Ears
	Mating Alignment Type	Polarization
	PCB Mount Alignment	Without
	Mating Retention Type	Latch
Housing Features	UL Flammability Rating	UL 94V-0
	Housing Color	Black
	Housing Material	Polyphenylene Sulfide (PPS)
Dimensions	Width	19.3 mm [ .76 in ]
	Height	12.7 mm [ .5 in ]
	PCB Thickness (Recommended)	1.57 – 3.18 mm [ .062 – .1251 in ]
	Length	57.912 mm [ 2.28 in ]
Usage Conditions	Sealed Condition	Not Sealed
Operation/Application	Connector System	Wire-to-Board
	Applies To	Printed Circuit Board
	Operating Temperature	0 – 105 °C [32 – 221 °F]
	Circuit Application	Power
Industry Standards	VDE Tested	No
	CSA Rating	Certified
	Agency/Standard Number	E28476
	UL Rating	Recognized
	CSA File Number	LR 7189
	Agency/Standard	CSA, UL
Packaging Features	Packaging Method	Вох
	Packaging Quantity	100
Other	Backwall/Post Interruptions	Without
	For Use With	Header
Product Compliance	Statement of Compliance	

Statement of Compliance PDF

VIEW ALL PRODUCT COMPLIANCE